



Features

- Average Forward Current: $I_{F(AV)}=2A$
- Polarity: Color band denotes cathode



SMB



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
ES2A-ES2J	SMB	ES2x	3000

x: From A-J

Maxmim Ratings (Ta=25 unless otherwise noted)

Item	Symbol	Unit	Test Conditions	ES2											
				A	B	C	D	E	G	H	J				
Repetitive Peak Reverse Voltage	V_{RRM}	V		50	100	150	200	300	400	500	600				
Maximum RMS Voltage	V_{RMS}	V		35	70	105	140	210	280	350	420				
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, $T_a=110\text{ }^\circ\text{C}$	2.0											
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave, 1 cycle, $T_a=25\text{ }^\circ\text{C}$	50											
Operation Junction and Storage Temperature Range	T_J, T_{STG}	$^\circ\text{C}$		-55 ~ +150											

Electrcal Charcteristics (Ta=25 unless otherwise specified)

Item	Symbol	Unit	Test Condition	ES2									
				A	B	C	D	E	G	H	J		
Peak Forward Voltage	V_F	V	$I_F=2.0A$	0.95			1.25			1.7			
Maximum reverse recovery time	t_{rr}	ns	$I_F=0.5A, I_R=1.0A, I_{rr}=0.25A$	35									
Peak Reverse Current	I_{RRM1}	μA	$V_{RM}=V_{RRM}$	$T_a=25\text{ }^\circ\text{C}$			5.0						
	I_{RRM2}			$T_a=125\text{ }^\circ\text{C}$			50						
Thermal Resistance(Typical)	$R_{\theta J-A}$	$^\circ\text{C}/\text{W}$	Between junction and ambient	65									
	$R_{\theta J-L}$		Between junction and terminal	18									
Juction Capacitance (Typical)	C_j	pF	Measured at 1MHZ and Applied Reverse Voltage of 4.0 V.D.C	26					20				

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.27" x 0.27" (7.0 mm x 7.0 mm) copper pad areas



Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

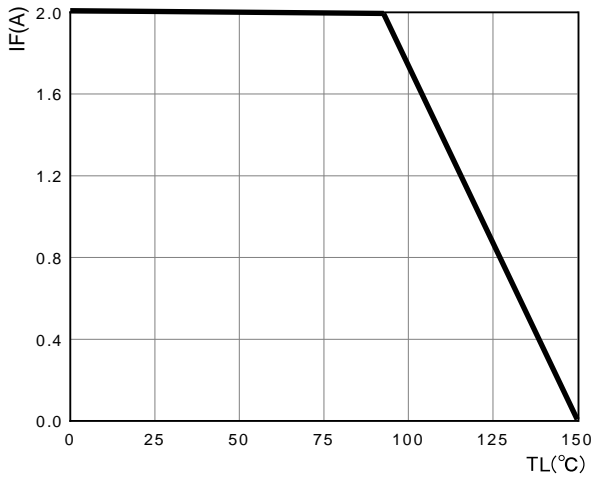
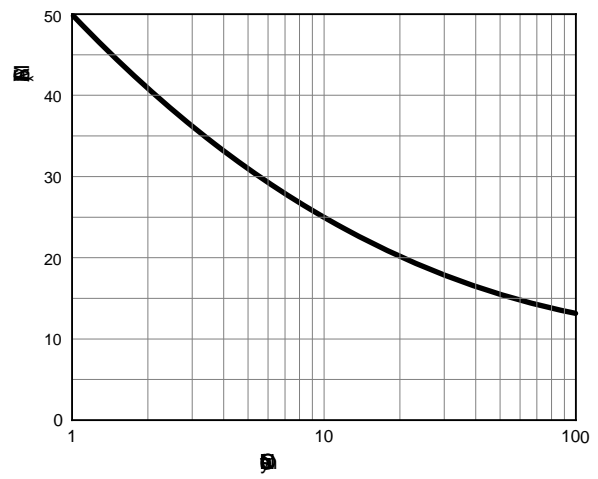
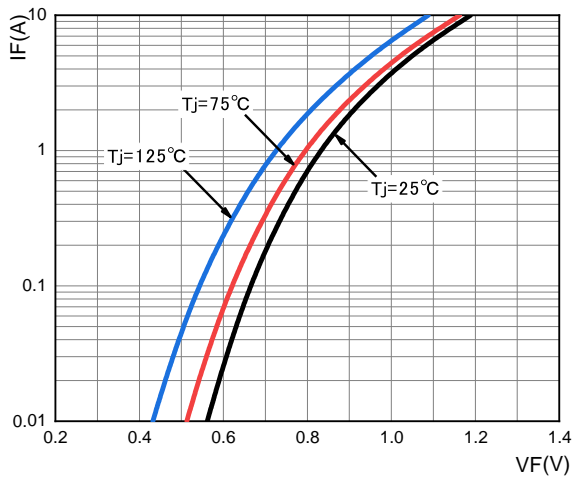


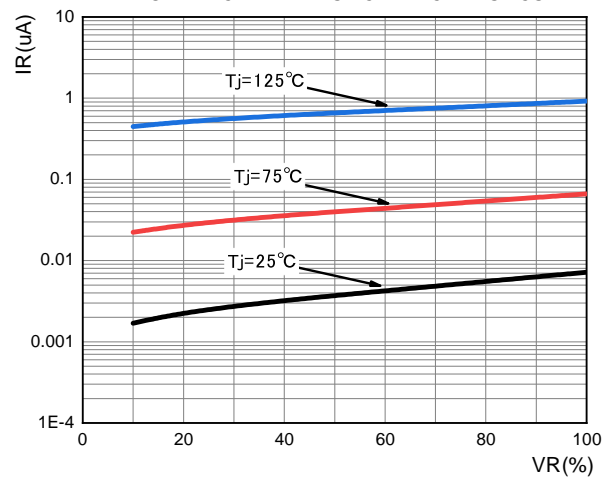
FIG.2:



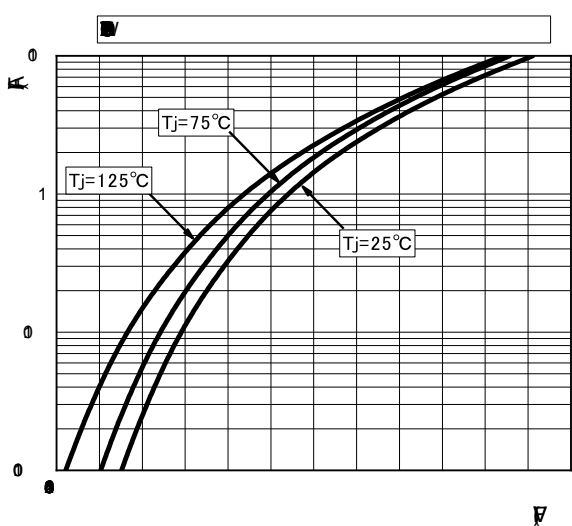
ES2A-ES2D
FIG.3: TYPICAL FORWARD CHARACTERISTICS



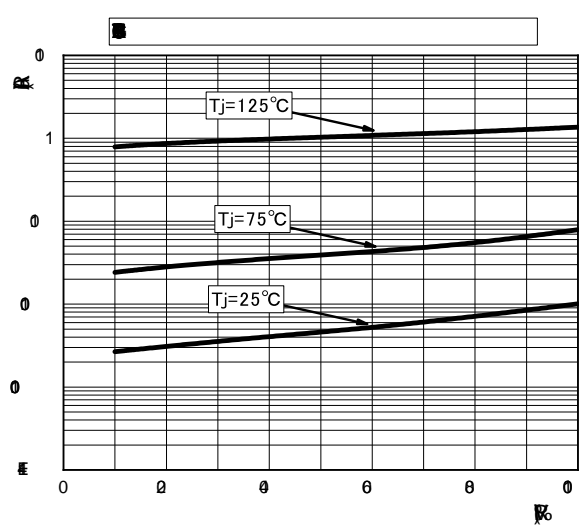
ES2A-ES2D
FIG.4 TYPICAL REVERSE CHARACTERISTICS

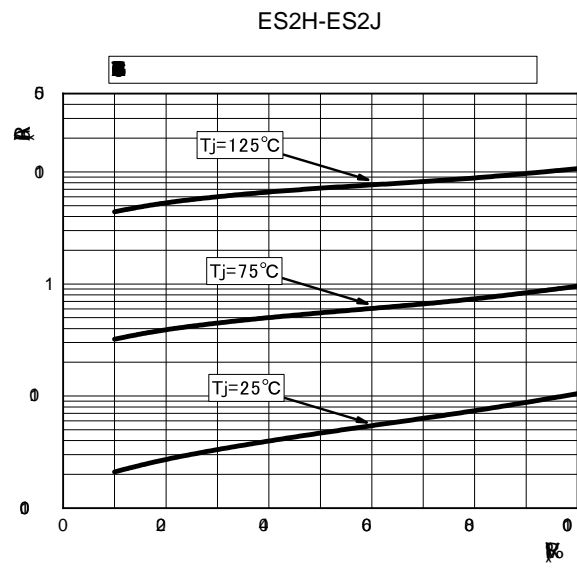
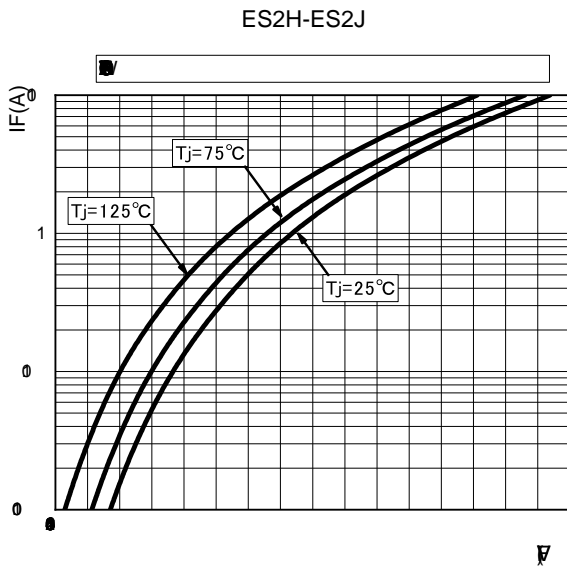


ES2E-ES2G



ES2E-ES2G

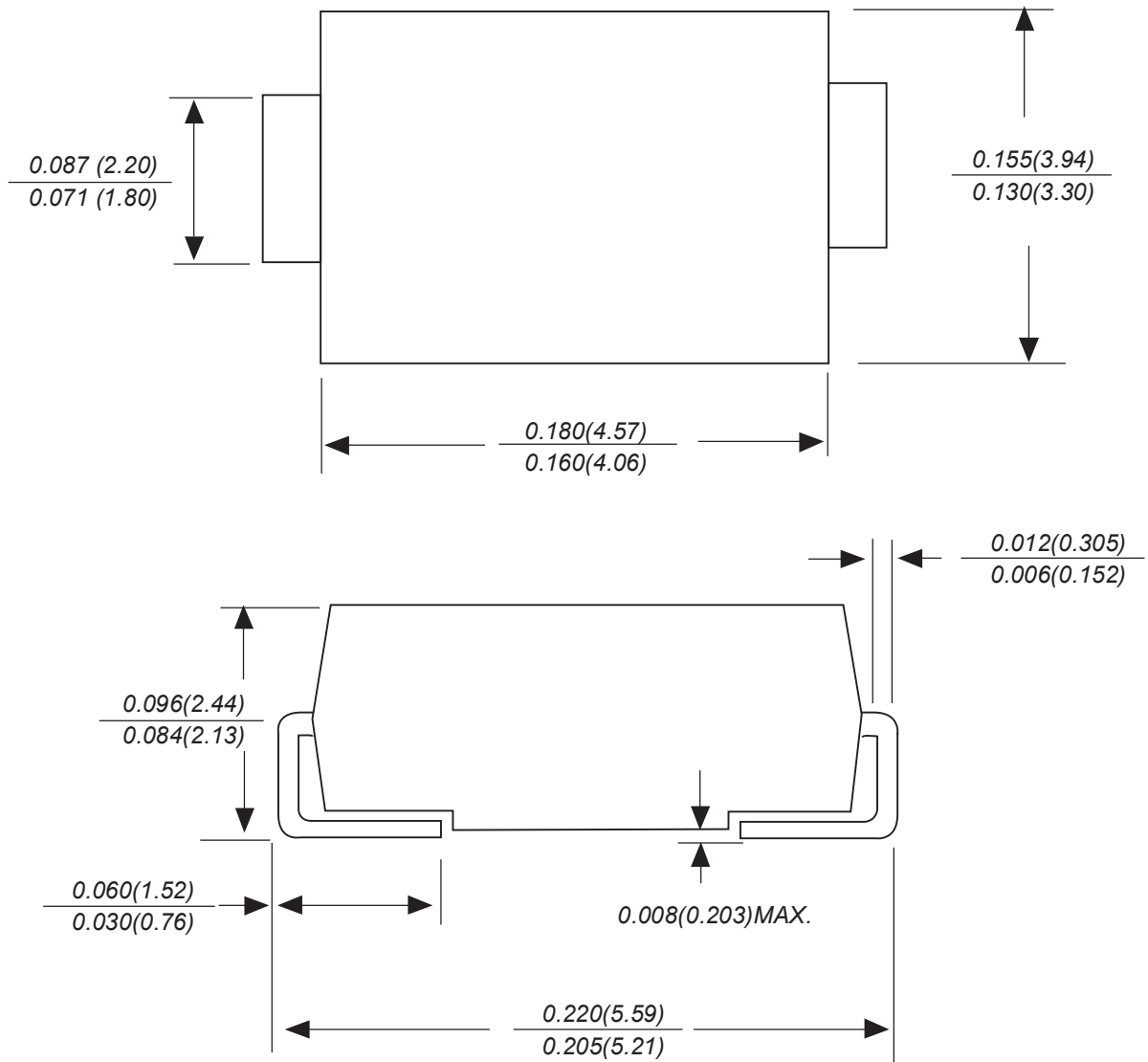






Package Outline Dimensions

SMB



Dimensions in inches and (millimeters)



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